TOSHIBA Photocoupler Photorelay

TLX9150M

1. Description

Toshiba TLX9150M consists of an infrared emitting diode optically coupled to a photo-MOSFET in a SO12L-T package.

This coupler uses high voltage MOSFET between output terminals, making it suitable for battery-related control applications.

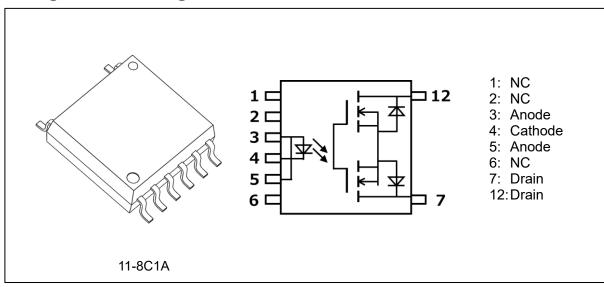
2. Applications

- Battery Control in Automotive Equipment
- Fuel Battery Control in Automotive Equipment
- Application for Electrical Vehicle

3. Features

- Normally open (1-Form-A) device
- Peak off-state voltage: 900 V (min)
- Trigger LED current: 3 mA (max)
- On-state current: 50 mA (max)
- On-state resistance: 250Ω (max)(@t < 1s)
- Isolation voltage: 5000 Vrms (min)
- Clearance distance: 8 mm (min)
- Creepage distance: 8 mm (min)
- Insulation thickness: 0.4 mm (min)
- Outer resin: CTI > 600
- AEC-Q101 qualified

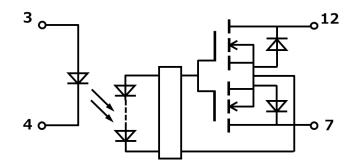
4. Packing and Pin Assignments



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5. Internal Circuit



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6. Absolute Maximum Ratings (Note) (Unless otherwise specified, T_a = 25°C)

	Characteris	stics	Symbol	Note	Rating	Unit
LED	Forward current	lF		30	mA	
	Forward current derating $(T_a \ge T_a)$	100 °C)	∆I⊧/°C		-0.8	mA/°C
	Reverse voltage		VR		5	V
	Input Power Dissipation		PD		50	mW
	Input Power Dissipation Deratin	∆P _D /°C		-1.3	mW/°C	
	Junction temperature		Tj		135	°C
Detector		T _a = 25 °C			50	mA
	On-state current	T _a = 105 °C	ION		20	mA
		T _a = 125 °C			10	mA
	On-state current derating	T _a ≥ 45 °C	Δlon/°C		-0.5	mA/°C
		T _a = 25 °C		(Note 1)	150	mA
	On-state current (Peak)	T _a = 105 °C	IONpk		60	mA
		T _a = 125 °C			30	mA
	Avalanche current		IAV	(Note 2)	0.6	mA
	Output power dissipation		Po		600	mW
	Output power dissipation derati	ng (Ta≥47°C)	ΔPo/°C		-7	mW/°C
	Junction temperature		Tj		135	°C
Common	Storage temperature	T _{stg}		-55 to 150	°C	
	Operating temperature	T _{opr}		-40 to 125	°C	
	Lead soldering temperature (10	T _{sol}		260	°C	
	Isolation voltage (AC, 60 s, R.H	l. ≤ 60%)	BVs	(Note 3)	5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note: This product is more sensitive than conventional products to electrostatic discharge (ESD). It is therefore all the more necessary to observe general precautions regarding ESD when handling this component.

Note 1: Exponential curve, pulse width < 1ms, $f \le 150$ Hz

Note 2: 1min (max continuous), Duty cycle=0.1%, 5 time over lifetime.

Note 3: LED pins are shorted together. Detector pins are also shorted together.

7. Recommended Operating Conditions (Note)

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	V _{DD}	_	_	720	V
Forward current	lF	5	10	20	mA
On-state current	I _{ON}	_	_	50	mA
Operating temperature	T _{opr}	-40		125	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

8. Electrical Characteristics (Unless otherwise specified, $T_a = 25^{\circ}C$)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
LED	Forward voltage		I _F = 10 mA	1.5	1.65	1.8		
		VF	I _F = 10 mA, T _a =-40 to 125°C	1.4	_	1.95	V	
	Reverse current	I _R V _R = 5 V				10	μA	
	Capacitance	Ст	V = 0 V, f = 1MHz		45	_	pF	
Detector	Output withstand voltage	Voff	_F I _{OFF} = 10 μA, T _a = 25 °C			_	V	
	Off-state current		V _{OFF} = 900 V, T _a = 25 °C			100		
		IOFF	V _{OFF} = 900 V, T _a = -40 to 105 °C			1000	nA	
			V _{OFF} = 900 V, T _a = -40 to 125 °C			5000		
Capacitance C_{OFF} V = 0 V, f		V = 0 V, f = 1 MHz		60	_	pF		

9. Coupled Electrical Characteristics

Characteristics	Symbol	Test Condition		Тур.	Max	Unit			
Trigger LED current		I _{ON} = 50 mA, T _a = 25°C, t = 10 ms		—	3				
	IFT	I _{ON} = 20 mA, T _a = -40 to 105°C, t = 10 ms		_	3 mA				
		I _{ON} = 10 mA, T _a = -40 to 125°C, t = 10 ms		_	3				
Return LED current	IFC	I_{OFF} = 100 µA, T _a = -40 to 125°C, t = 40 ms	0.05	_	_	mA			
On-state resistance		I _{ON} = 50 mA, I _F = 10 mA, T _a = 25°C, t < 1 s	_	_	250				
	Ron	$I_{ON} = 20 \text{ mA}, I_F = 10 \text{ mA},$ $T_a = -40 \text{ to } 105 \text{ °C}, t < 1 \text{ s}$		—	350	Ω			
		I _{ON} = 10 mA, I _F = 10 mA, T _a = -40 to 125° C, t < 1 s		—	400				

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10. Isolation Characteristics (Ta = 25°C)

Characteristics	Symbol	Note	Test Condition		Тур.	Max	Unit
Capacitance input to output	Cs	(Note1)	Vs = 0 V, f = 1 MHz	—	0.9	_	pF
Isolation resistance	Rs	(Note1)	Vs = 1000V, R.H. ≤ 60 %	5×10 ¹⁰	10 ¹⁴	_	Ω
Isolation voltage	BVs	(Note1)	AC, 60 s	5000	_	_	Vrms

Note1: Device considered a two-terminal device: Pins 1 to 6 shorted together, and 7 and 12 shorted together.

11. Switching Characteristics

Characteristics	Symbol	Note	Test Condition		Min	Тур.	Max	Unit
Turn on time	t _{ON}		I _F = 10 mA	T _a = 25 °C	_		1	
Turn off time	toff		R _L = 20 kΩ V _{DD} = 40 V		_	_	1	ms
Turn on time	ton		- -	T _a = -40 to 125°C	_		1	
Turn off time	t _{OFF}				_		1	ms

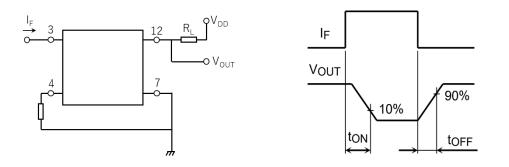
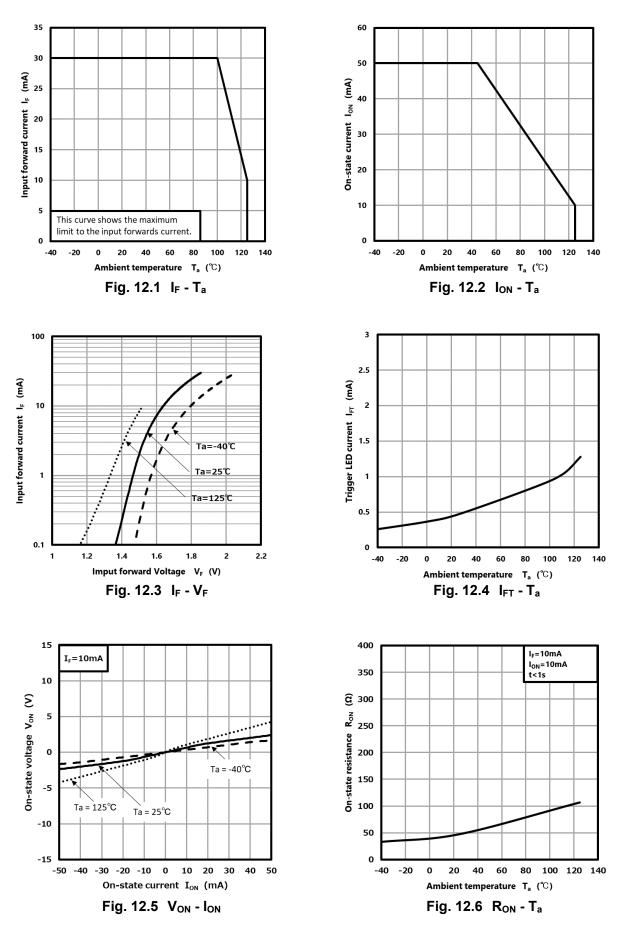
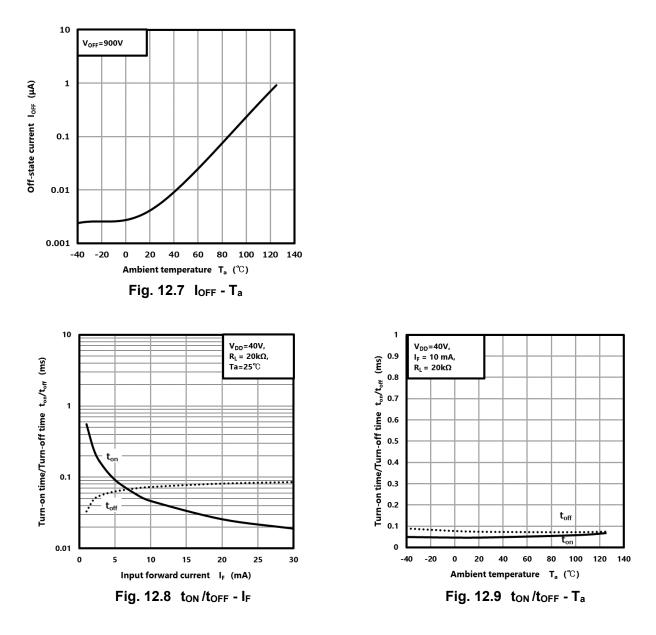


Fig. 11.1 Switching Time Test Circuit and Waveform

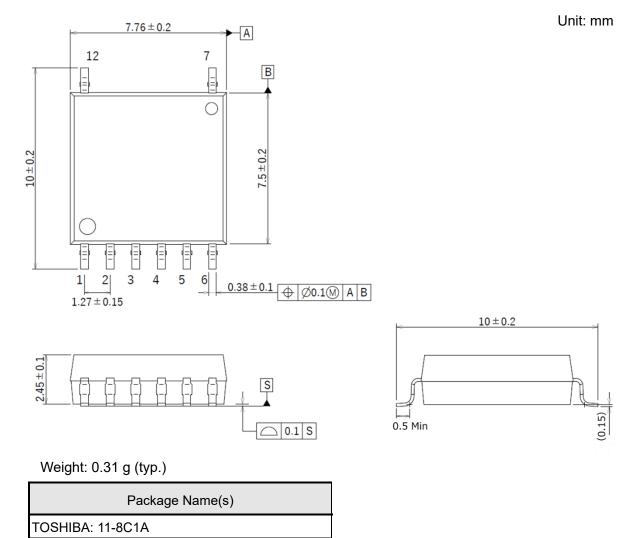
12. Characteristics Curves (Note)





Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

13. Package Dimensions



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